



# BiSon64-ET-B SUN SENSOR

## PRODUCT SPECIFICATION DOCUMENT

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**DOCUMENT CHANGE RECORD**

Issue	Date	Total pages	Pages affected	Brief description of change
1	28-09-2017	16	All	New document
1a	13-10-2017	14	All	Removed typo's like double Req. numbers to come in line with the verification control document. Added [AD] numbers where needed.
1b	05-10-2018	15	9,11-15	Cover picture added and Update: 4 Optical interfaces, 6.1 storage conditions, 6.4 temp cycling, 6.5.3 Random vibrations, 6.5.4 Shock specification, 6.6 Cosmic radiation resistance
1c	09-10-2018	15	All	Removed typo's
1d	06-11-2018	15	8	Removed typo
2	3-5-2019	15	11, 14	Update shock specification and thermal cycling
3	28-05-2019	15	9	Update mass to come in line with VCD and ICD
3a	18-06-2019	16	10	Update transition resistance and random vibration time
4	19-05-2020	16	12-16	Par 6.4, update temperature cycling Par 6.5, update vibration specifications Added Par 6.7
5	11-08-2020	16	All	Added the IC-document, replaced photo. Removed typos. Update, to come in line with the BiSon64-ET specs.
5a	04-12-2020	16	7	Clarification update of equations



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## Abbreviations

AD	Applicable Document
ADC	Analogue to Digital Converter
-B	Baffle
BOL	Begin of Life
COTS	Commercial Off The Shelf
CTE	Coefficient of Thermal Expansion
EMC	Electro Magnetic Compatibility
EOL	End of Life
-ET	Extended Temperature
FOV	Field of View
ICD	Interface Control Document
LOS	Line Of Sight
MAIT	Manufacturing Assembly Integration and Test
NTC	Negative Temperature Coefficient resistor (thermistor)
PIND	Particle Induced Noise Detection
PSD	Power Spectral Density
RD	Reference Document
Req	Requirement

## Applicable documents

Nr	Document name	Document number	Issue
[AD-01]	BiSon64-ET-B interface control document	20-LRD-ICD-0002	1
[AD-02]	BiSon64-ET-B interface control drawing	150T701	04
[AD-03]	Precision fastener	500M085	01
[AD-04]	Washer vented	500M086	01
[AD-05]	Delivery, Packing, Storage, Handling, and Transportation procedure.	19-LRD-PR-0052	1

## Reference documents

Nr	Document number	Document name	Issue



## 1 Introduction

The BiSon64-ET-B sun sensor, see [Figure 1](#) is a high reliability sun sensor with a nominal field of view of 64 degrees in diagonal which is specifically designed for highly demanding satellite applications.

The ET stands for Extended Temperature and indicates that the sensor is developed to operate over a wide temperature range of up to  $-120^{\circ}\text{C}$ ... $+120^{\circ}\text{C}$ .

The B stands for Baffle and indicates that this straylight is specifically designed for demanding satellite applications.

This document shall be read in conjunction with the interface control document [AD-01] and the interface control drawing [AD-02].



**Figure 1 BiSon64-ET-B Sun sensor**



## 2 Solar direction angles

Apart from the quadrant definition as given in [AD-02] it is necessary to define the reference frame of the sun sensors in order to avoid sign errors in the attitude control subsystem. All BiSon64-ET-B sun sensors use the reference definition given below.

These diagrams provide the definition of the angles  $\alpha$  and  $\beta$  to be calculated by means of the formulas given in Equation 1. It can be deduced that a negative  $\alpha$  means that the sun is to the top of the sensor and that a negative  $\beta$  means that the sun is to the right of the sensor (both when viewed from the top side).

The illumination given in Figure 2 is for positive  $\alpha$  and positive  $\beta$  of the BiSon64-ET-B Sun sensor.

All BiSon64-ET-B sun sensors use the reference definition given in Equation 1. The definition is applicable for the non-compensated utilization. In order to improve the accuracy further the sensor can be implemented with standard calibration tables or using a simplified compensation formula, see Equation 2.

$$S_a = \frac{Q_1 + Q_4 - Q_2 - Q_3}{Q_1 + Q_2 + Q_3 + Q_4} = \frac{\tan(\alpha)}{\tan(\alpha_{max})}$$

$$S_b = \frac{Q_1 + Q_2 - Q_3 - Q_4}{Q_1 + Q_2 + Q_3 + Q_4} = \frac{\tan(\beta)}{\tan(\beta_{max})}$$

**Equation 1 BiSon64-ET  $\alpha$  and  $\beta$  formulas**

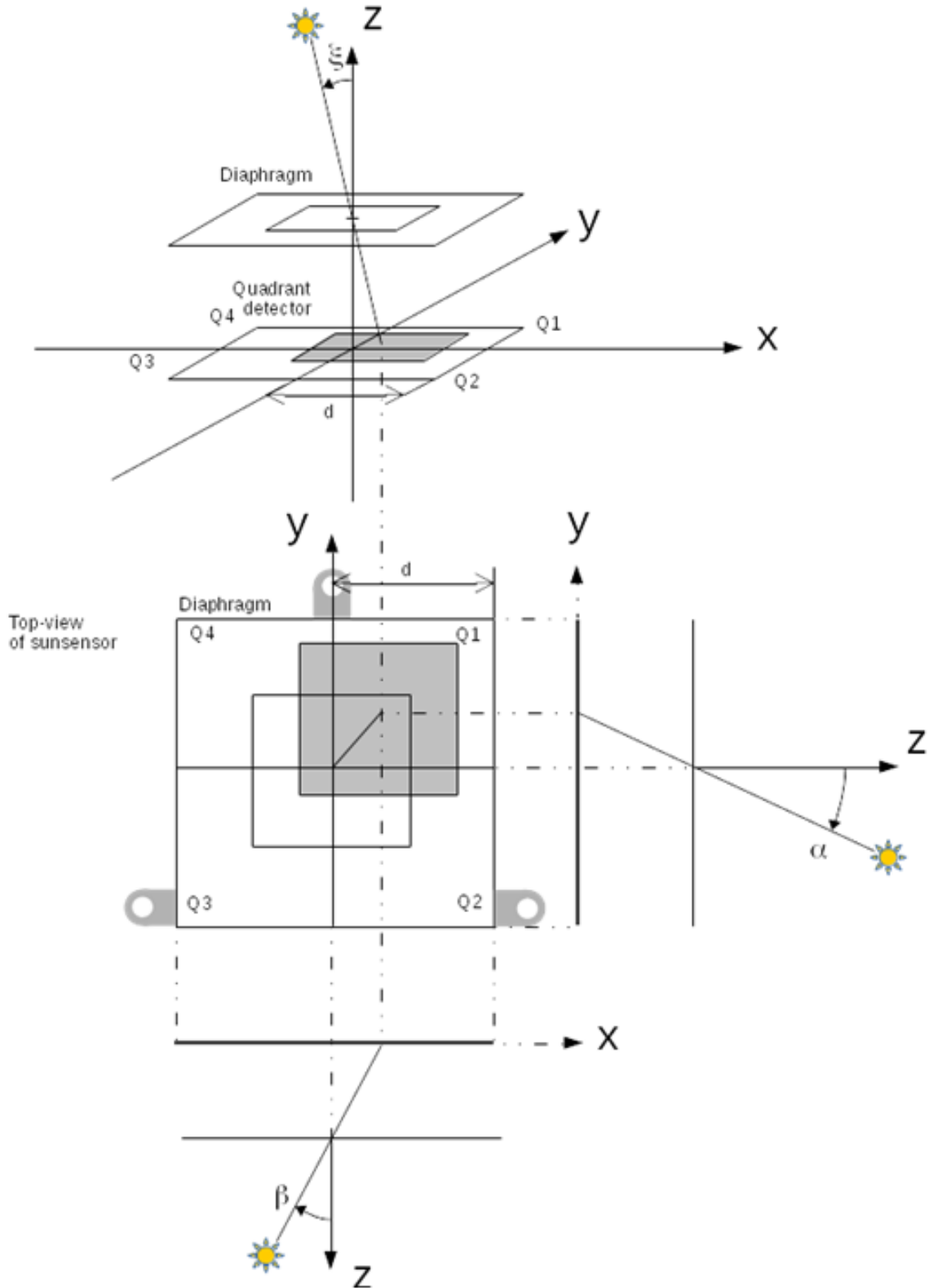
$$S_{a\_compensated} = S_a - C_a = \frac{Q_1 + Q_4 - Q_2 - Q_3}{Q_1 + Q_2 + Q_3 + Q_4} - C_a = \frac{\tan(\alpha)}{\tan(\alpha_{max})}$$

$$S_{b\_compensated} = S_b - C_b = \frac{Q_1 + Q_2 - Q_3 - Q_4}{Q_1 + Q_2 + Q_3 + Q_4} - C_b = \frac{\tan(\beta)}{\tan(\beta_{max})}$$

**Equation 2  $\alpha$  and  $\beta$  formulas with correction in radian**

$C_a$  is the offset correction parameter used to compensate zenith offset in the  $\alpha$  direction.

$C_b$  is the offset correction parameter used to compensate zenith offset in the  $\beta$  direction.



**Figure 2  $\alpha$  and  $\beta$  reference frame and angle visualization**





### 3 Mechanical interfaces

The dimensions of the mechanical interfaces are given in interface control drawing [AD-02]. The counterpart on which the Sensor will be mounted shall have at least the same accuracies as the sensor as defined in the IC- drawing.

The X axis of the right hand Cartesian reference system is defined by the line through the center of the lower right and lower left mounting points. The Z axis is fixed by means of the plane running through the three mounting feet.

#### 3.1 Repeatability of mounting

**Req. 3.1** The repeatability of mounting shall be better than 0.06 degrees, when using the prescribed mounting hardware (special fasteners with washers, [AD-03] and [AD-04]). The dimensions and accuracies of the counterpart on which the Sensor will be mounted shall be in line with the sensor specifications as stated on the ICD [AD-02] and assembly is according to the prescribed procedure as given in paragraph 6.3 of [AD-05].

#### 3.2 Fastening torque

The special fasteners defined in [AD-03] shall be fastened with a torque of  $1\text{Nm} \pm 10\%$ .

#### 3.3 Mass

**Req. 3.3** The mass of the unit is  $\leq 33$  grams but more accurately given on sheet 1 of [AD-02].

#### 3.4 Centre of gravity

The center of gravity is given on sheet 1 of [AD-02]. But there are no requirements on the CoG.

### 4 Optical interfaces

The optical interfaces are defined on sheet 2 of [AD-02] in combination with the reference frame definition as given in par 2.

**Req. 4-1** The field of view of the sensors shall be  $>63^\circ$  in both diagonals.

The actual angles and associated limits are given on sheet 2 of [AD-02].

## 5 Electrical interfaces

The electrical connections are as given on sheet 3 of [AD-02].

The sensor will generate 4 analogue currents.

**Req. 5-1** The currents generated shall be  $-1.45\text{mA} \pm 20\%$  at normal incidence at  $20^\circ\text{C} \pm 5^\circ\text{C}$ .

**Req. 5-2** Requirement deleted.

**Req. 5-3** The currents generated shall be  $-1.45\text{mA} \pm 60\%$  at normal incidence over the full temperature range.

**Req. 5-4** Requirement deleted.

These values are at  $1 \text{ Am}(0)$  sun illumination and 0 bias (measured with a transimpedance amplifier) over the full temperature range.

**Req. 5-5** The internal thermistor shall have a nominal value of  $10\text{k}\Omega \pm 10\%$  @  $25^\circ\text{C}$ .

### 5.1 Grounding and isolation

**Req. 5.1-1** The resistance from the common ground to case shall be  $1\text{M}\Omega < R < 10\text{M}\Omega$ .

**Req. 5.1-2** The capacitance between the sensor and ground shall be  $< 100\text{pF}$ .

**Req. 5.1-3** The resistance from sapphire window to housing shall be  $< 1\text{M}\Omega$

**Req. 5.1-4** The resistance from baffle to housing shall be  $< 20\text{m}\Omega$

### 5.1 Deleted

**Req. 5.2-1** Requirement deleted.

### 5.2 Specified accuracy

**Req. 5.3-1** The specified accuracy for the sensors is better than 3.5 degrees if no calibration table is used.

**Req. 5.3-2** The specified accuracy for the sensors is better than 2 degree if a sensor specific offset and gain correction is implemented.

**Req. 5.3-3** The specified accuracy for the sensors is better than 0.5 degree  $3\sigma$  if calibration tables are used.



## 6 Environmental specifications

### 6.1 Storage conditions

**Req. 6.1** The sensor should be stored in a dust free, dry and temperature controlled environment with a temperature range of 0°C to +30 °C and a relative humidity of 40% to 60% storage lifetime under these conditions is longer than 5 years when kept in the original packaging.

### 6.2 Operating temperature range

**Req. 6.2** The sensors shall perform within specifications when operated in the range of -120°C to +120°C.

### 6.3 Non-operating temperature range

**Req. 6.3** The sensors shall survive a non-operating temperature range of -125°C to +125°C.

### 6.4 Temperature cycling

The sensors shall meet the temperature cycling requirements specified in [Table 1](#).

Req.	Conditions	Temperature range	Number of cycles
6.4-1	Deleted (replace by acceptance test)		
6.4-2	Full range high rate thermal cycle in vacuum (qualification)	-125°C....+125°C	10
6.4-3	Thermal vacuum cycling (qualification)	-40°C....+80°C -45°C....+105°C	1000 1000

**Table 1 Thermal cycling specification**

### 6.5 Vibration specifications

Vibration specifications of the sensor are given below. It should be noted that these are already verified qualification levels. Any safety margins required for the mission shall therefore be subtracted from the given level to see if the sensors meet mission requirements. The sine and random qualifications have been performed using the in [AD-03] and [AD-04] defined hardware and torqued to the level specified in chapter 3.2.

#### 6.5.1 Eigenfrequency

**Req. 6.5.1-1** The first eigenfrequency shall be > 200Hz.



**6.5.2 Sine vibration**

**Req. 6.5.2-1** The sensors shall be able to function within specifications after being subject to vibration test levels specified in [Table 2](#) in all three axes.

Sine vibrations	
Frequency Hz	Level
5...44.6	20mm peak to peak 10mm zero to peak
44.6...100	40g
1 octave/minute 1 sweep up/1 sweep down	

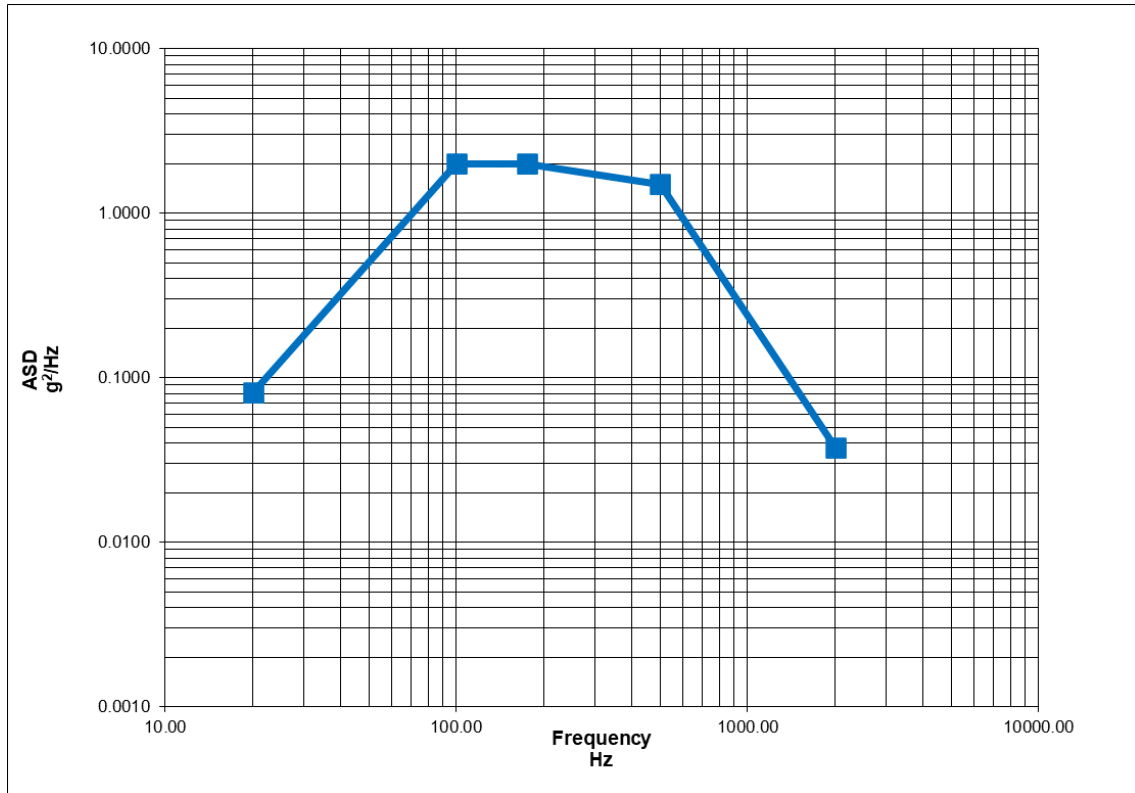
**Table 2 Sine vibrations (qualification)**

**6.5.3 Random vibrations qualification**

**Req. 6.5.3** The sensor shall be able to function within specifications after being subjected to vibration test levels specified in [Table 3](#) and [Figure 3](#) in all three axes.

Random vibrations						
Frequency (Hz)	ASD (G <sup>2</sup> /Hz)	dB	OCT	dB/OCT	Area	Grms
20.00	0.0810	*	*	*	*	*
100.00	2.0000	13.93	2.32	6.00	66.30	8.14
175.00	2.0000	0.00	0.81	0.00	216.30	14.71
500.00	1.5000	-1.25	1.51	-0.82	767.28	27.70
2000.00	0.0376	-16.01	2.00	-8.00	1174.02	34.26
Total RMS level: 34.26g						
Duration: 180 seconds						

**Table 3 Random vibrations (qualification)**



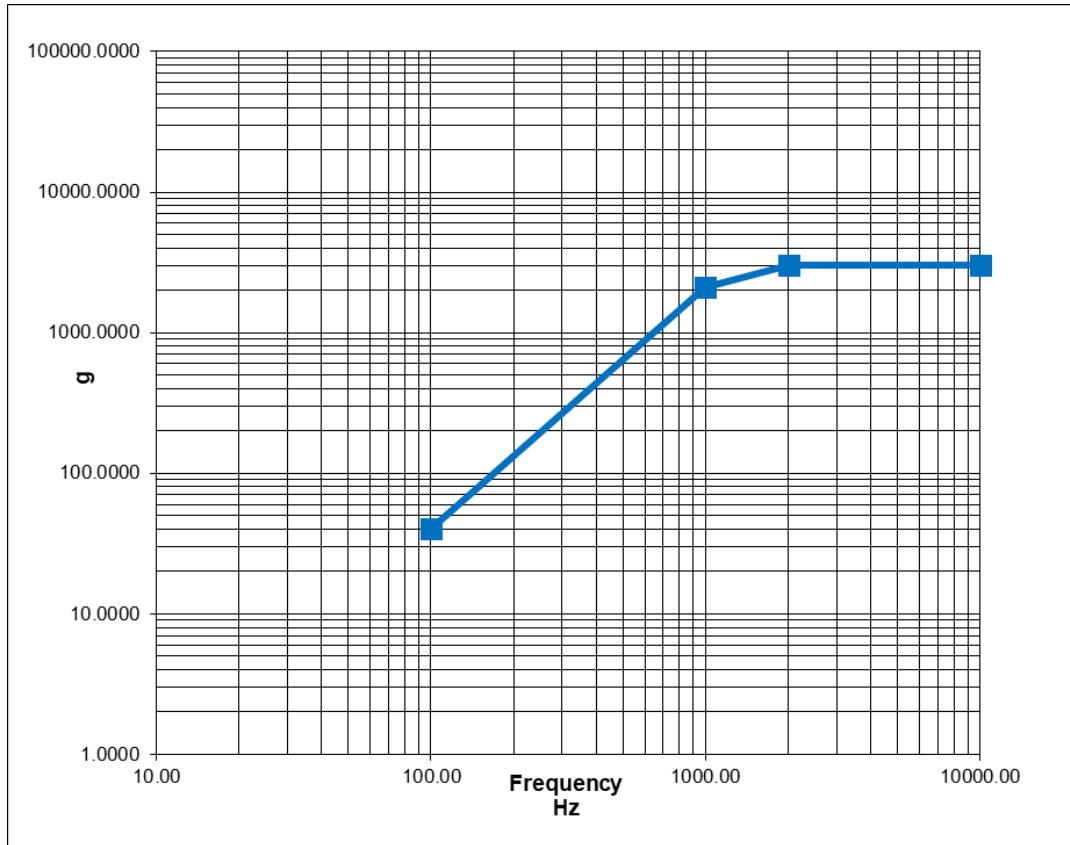
**Figure 3 Random vibration profile (qualification)**

**6.5.4 Shock specification**

**Req. 6.5.4** The sensor shall be able to function within specifications after being subject to vibration test levels specified in [Table 4](#) and [Figure 4](#) in all three axes.

Pyro shock	
Frequency Hz	Level g
100	40
1000	2100
2000	3000
10000	3000
3 shocks in any direction	

**Table 4 Pyro shock specifications (qualification)**



**Figure 4 Pyro shock profile (qualification)**

**6.5.5 PIND testing**

**Req. 6.5.5** requirement deleted

**6.6 Cosmic radiation resistance**

**Req. 6.6** Bare diodes shall sustain  $4E14$  1MeV electron testing without failure at a fluence of  $1E11$  electrons per second. Tolerance on radiation test parameters shall be  $\pm 5\%$ .



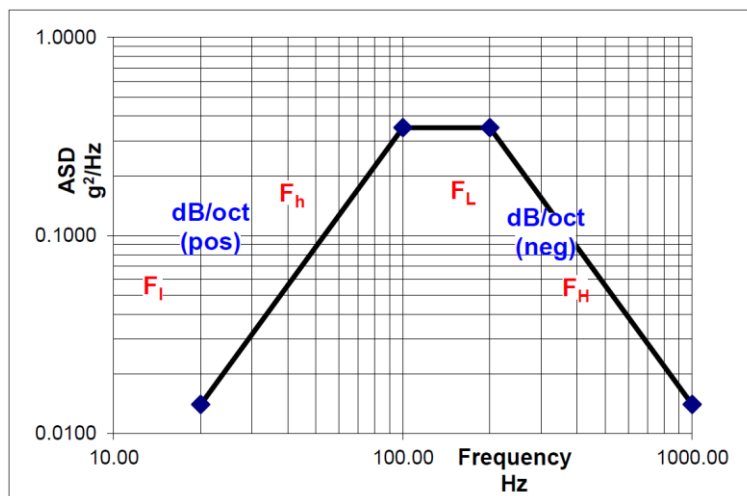
## 6.7 Standard acceptance testing activities

### 6.7.1 Vibration testing

**Req. 6.7.1** Unless specifically agreed upon a deviation, the sensors shall be exposed to random vibration in the Z-axis only for which the levels are specified in [Table 5](#) and [Figure 5](#) as part of the acceptance test sequence.

Acceptance vibration test						
				Slope	Acceleration	
Frequency Hz	ASD G <sup>2</sup> /Hz	dB	OCT	dB/OCT	Area	Grms
20.00	0.0140	*	*	*	*	*
100.00	0.3500	13.98	2.32	6.02	11.57	3.40
200.00	0.3500	0.00	1.00	0.00	46.57	6.82
1000.00	0.0140	-13.98	2.32	-6.02	102.57	10.13
Total RMS level: 10.13 g						
Duration: 90 seconds						

**Table 5 Random vibrations (acceptance)**



**Figure 5 Random vibration profile (acceptance)**



### 6.7.2 Acceptance thermal cycling

**Req. 6.7.2** Unless specifically agreed upon a deviation, the sensors shall be exposed to 10 thermal vacuum cycles between  $-40^{\circ}\text{C}$  and  $+80^{\circ}\text{C}$  as part of the acceptance test sequence.

### 6.7.3 Acceptance calibration

**Req. 6.7.3** Unless specifically agreed upon a deviation, the sensors shall be calibrated before delivery.

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